

Specifications for Approval

Customer Part No.:

Inhere Part No.: S3010FSPKD-001

Part Name: 3010 粉红光 LED

Spec Issue Date: 2018-07-15

Revision No.: A

To Customer:

We submit herewith the following information for your approval:

- Sample OQC Inspection Record LED Dimension
 Electrical Characteristics Curve Internal Circuit Diagram
 Soldering recommendation

Prepared by: Lily

Date: 2018-07-15

Checked by: Tom

Date: 2018-07-15

Approved by: Wangxiaojun

Date: 2018-07-15

Customer Opinion

- Approve and no objection
 Reject with the following reason:

inhere 
light for your mind
银河光电

东莞市银河光电有限公司
DongGuan Inhere Opto CO.,LTD.
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Http://www.inhereopto.com

Features

3.0mm × 1.0mm SMD LED, 1.9mm thickness

Low power consumption

Wide view angle

Package: 3000pcs/reel

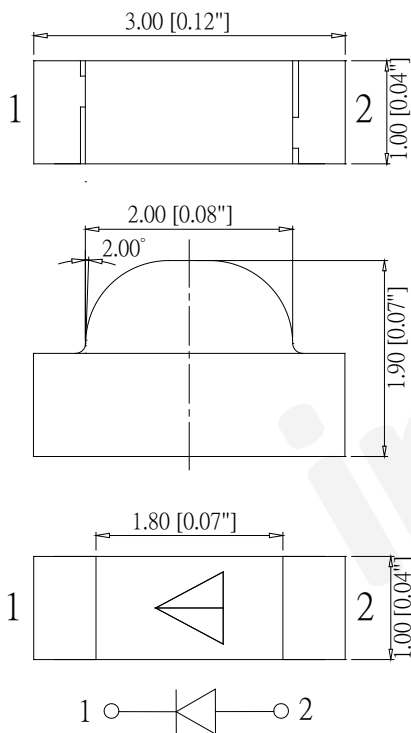
RoHS Compliant

Applications

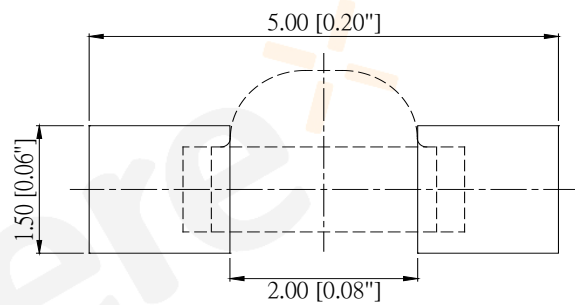
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color
S3010FSPKD-001	Pink	InGaN/GaN	Orange

Notes:

All dimensions are in millimeters (inches);

Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

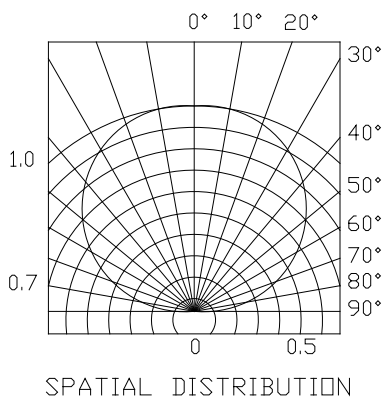
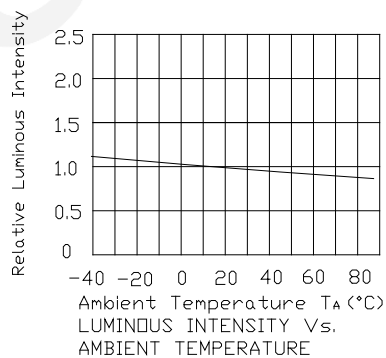
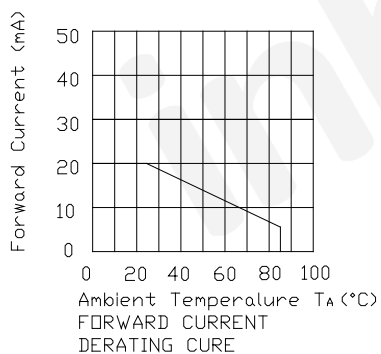
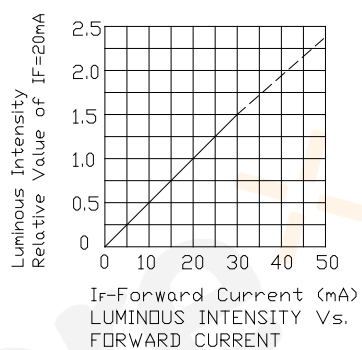
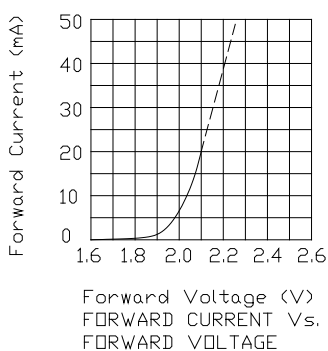
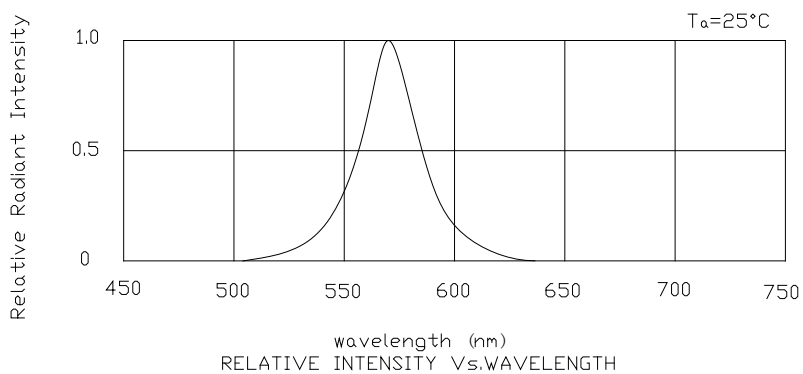
Absolute Maximum Ratings (TA=25 °C)

Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	108	mW
Operating temperature	Top	-40 ~+80	°C
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

Electro-Optical Characteristics (TA=25 °C)

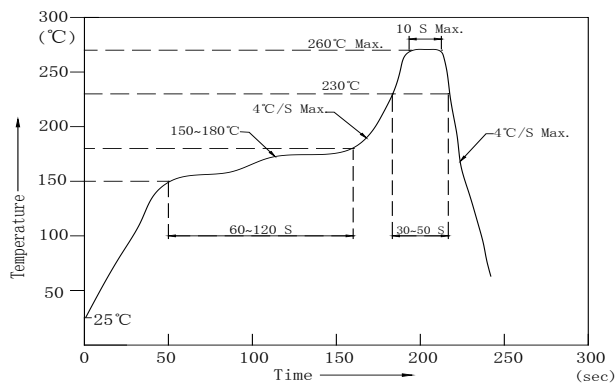
Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
CIE Coordinates	If=20mA	X	0.274	--	0.345	--
		Y	0.146	--	0.225	
Forward voltage	If=20mA	Vf	2.8	--	3.6	V
Luminous intensity	If=20mA	Iv	500	800	--	mcd
Viewing angle at 50% Iv	If=10mA	2θ1/2	--	125	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	μA

Optical Characteristic Curves



Reflow Profile

■ Reflow Temp/Time



Notes:

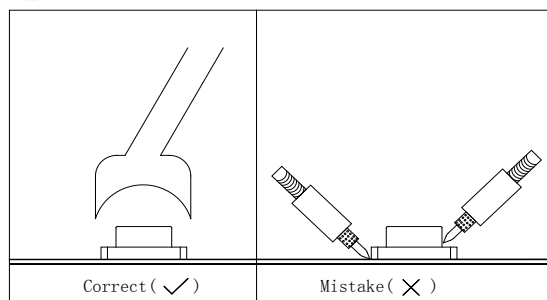
1. We recommend the reflow temperature 245°C ($\pm 5^{\circ}\text{C}$).the maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is $\leq 5\text{sec}$ when 320°C ($\pm 20^{\circ}\text{C}$). If temperature is higher, time should be shorter ($+10^{\circ}\text{C} \rightarrow -1\text{sec}$). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C .

■Rework

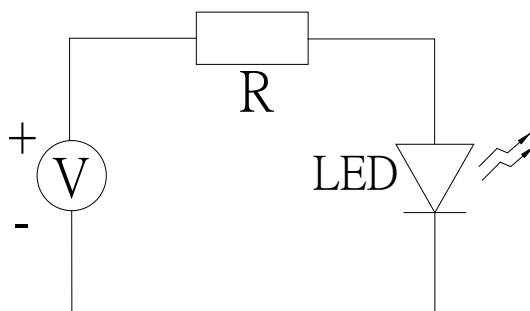
1. Customer must finish rework within 5 sec under 340°C .
2. The head of iron cannot touch copper foil
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at $5^{\circ}\text{C}\sim 30^{\circ}\text{C}$ and <math>< 30\% \text{ R.H.}</math> after the package is opened, the products should be used within a week or they should be keeping to stored at $\leq 20 \text{ R.H.}$ with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 $60\pm 3^{\circ}\text{C}$ x (12~24hrs) and <math>< 5\% \text{RH}</math>, taped reel type

3.2 $100\pm 3^{\circ}\text{C}$ x (45min~1hr), bulk type

3.3 $130\pm 3^{\circ}\text{C}$ x (15~30min), bulk type

Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min ↑→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃~100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH	--	1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
H	2.8	2.9	V
I	2.9	3.0	
J	3.0	3.1	
K	3.1	3.2	
L	3.2	3.3	
M	3.3	3.4	
N	3.4	3.5	
O	3.5	3.6	

Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
Q	500	630	mcd
R	630	800	
S	800	1000	
T	1000	1250	
U	1250	--	

Chromaticity coordinates Ranks combination (IF=20mA)

Rank	Chromaticity coordinates				
	K	X	0.286	0.274	0.285
Y		0.146	0.157	0.168	0.157
L	X	0.297	0.285	0.296	0.308
	Y	0.157	0.168	0.179	0.168
M	X	0.308	0.296	0.310	0.322
	Y	0.168	0.179	0.192	0.181
N	X	0.322	0.31	0.322	0.333
	Y	0.181	0.192	0.203	0.192
O	X	0.333	0.322	0.334	0.345
	Y	0.192	0.203	0.214	0.203

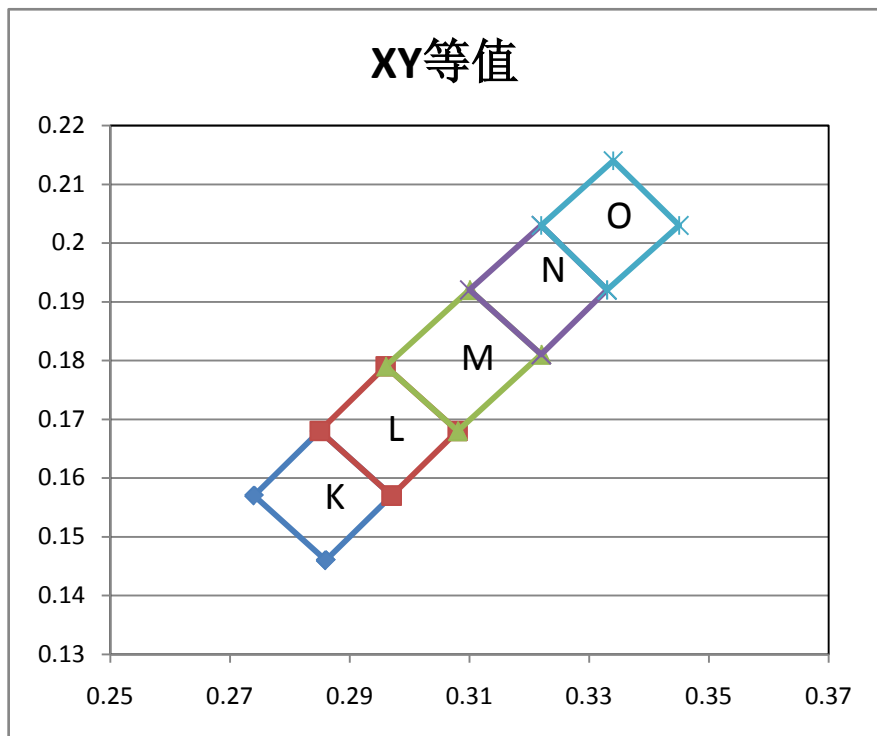
Group Name on Label (Example DATA: I R M 20)

DATA: I R M 20	Vf(V)	Iv (mcd)	CIE(X,Y)	Test Condition
I→R→M→20	2.9~3.0	630~800	X(0.296~0.322),Y(0.168~0.192)	IF=20mA

Notes:

- 1.The tolerance of luminous intensity (Iv)is $\pm 15\%$.
2. The tolerance of CIE Coordinates(X,Y) ± 0.01 .
3. This specification is preliminary.
4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

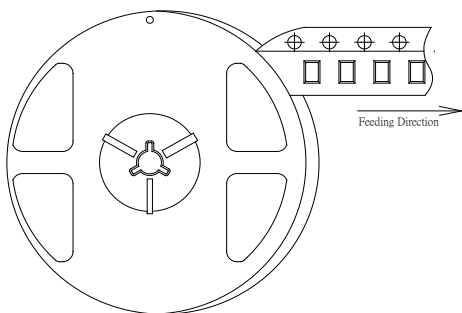
XY chromaticity coordinate



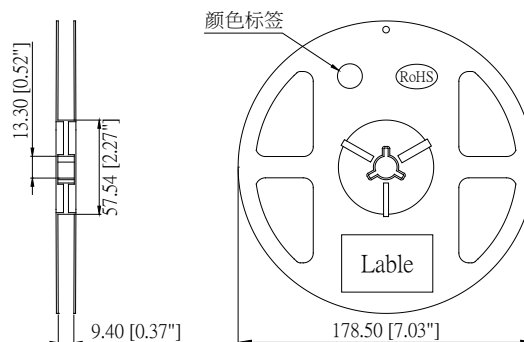
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3010 Series SMD Chip LED Lamps Packaging Specifications

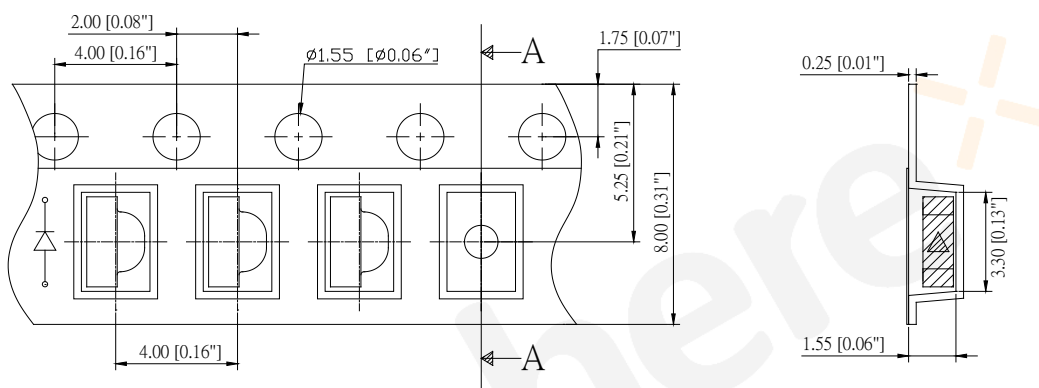
● Feeding Direction



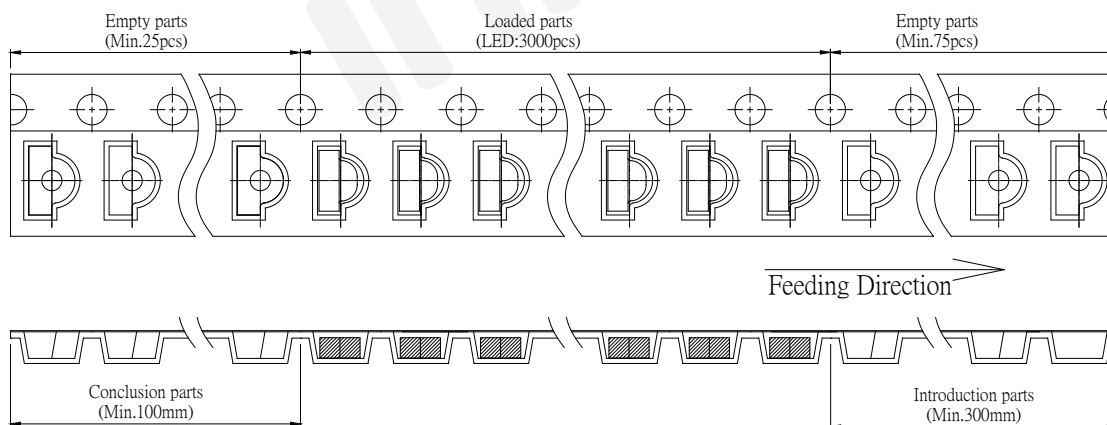
● Dimensions of Reel (Unit: mm)



● Dimensions of Tape (Unit: mm)



● Arrangement of Tape



Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 3,000pcs/Reel.

